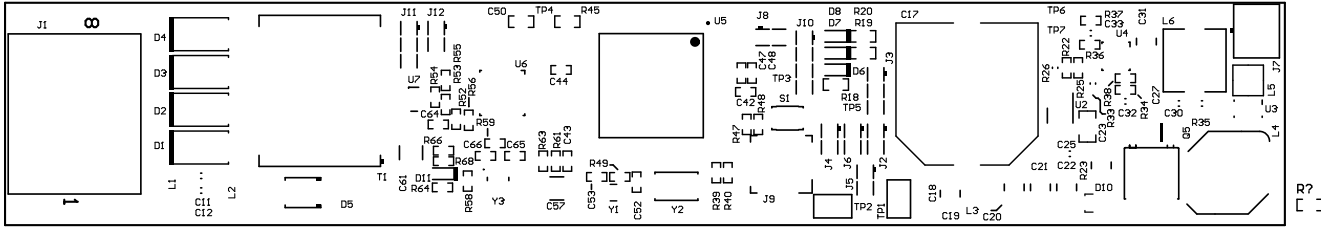
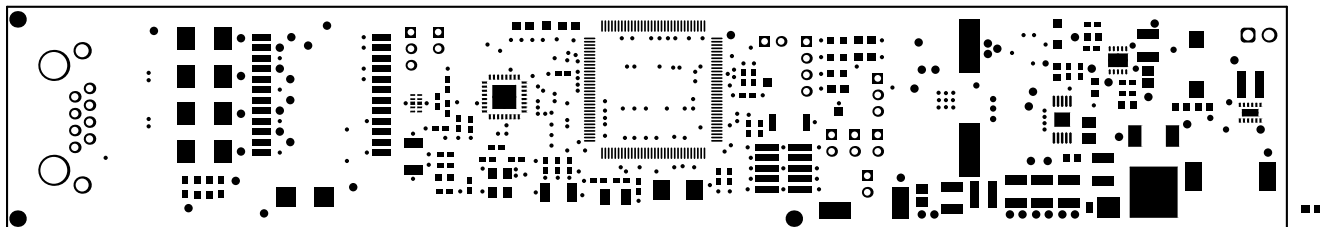


SH-35
 SH-34
 SH-33
 SH-31
 SH-32
 SH-37
 SH-38
 SH-36

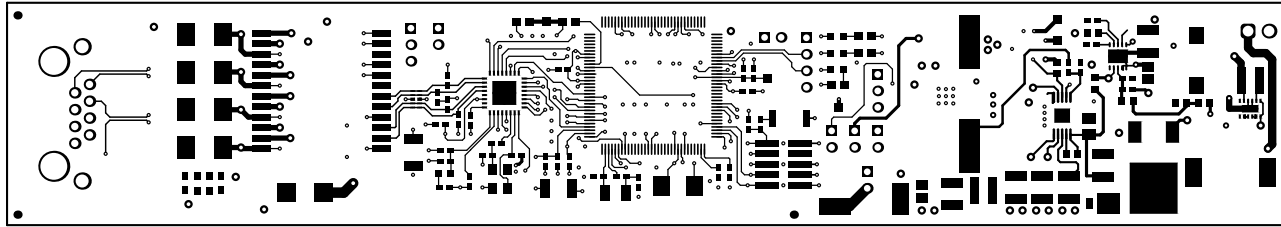


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01463	REV: A	SUN REV: Not In VersionControl
LAYER NAME =	TID #: TIDA-01463		
PLOT NAME = Top Overlay	GENERATED : 11/2/2017 2:17:25 PM	TEXAS INSTRUMENTS	



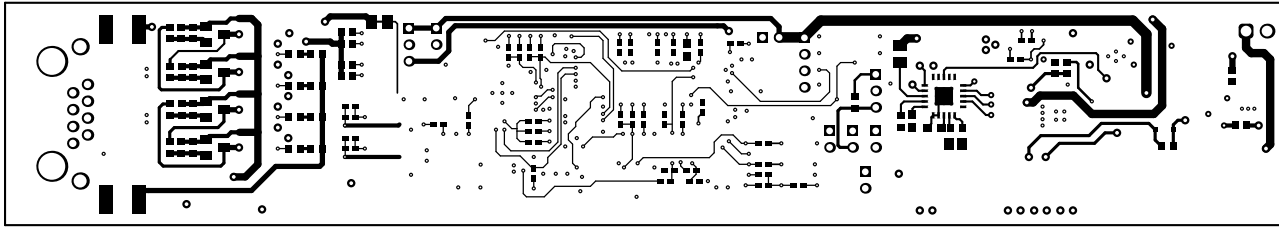
..

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01463	REV: A	SUN REV: Not In VersionControl
LAYER NAME =	TID #: TIDA-01463		
PLOT NAME = Top Solder Mask	GENERATED : 11/2/2017 2:17:27 PM	TEXAS INSTRUMENTS	

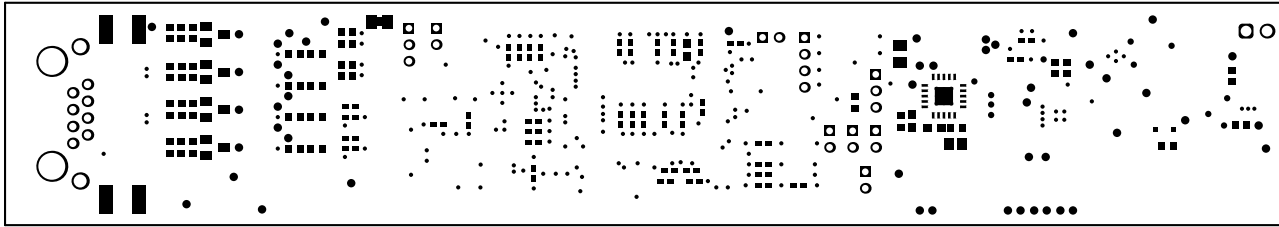


..

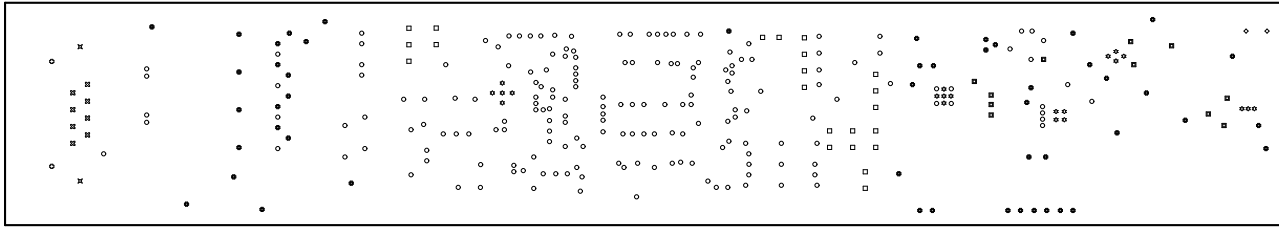
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01463	REV: A	SUN REV: Not In VersionControl
LAYER NAME =	TID #: TIDA-01463		
PLOT NAME = Top Layer	GENERATED : 11/2/2017 2:17:28 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01463	REV: A	SUN REV: Not In VersionControl
LAYER NAME =	TID #: TIDA-01463		
PLOT NAME = Bottom Layer	GENERATED : 11/2/2017 2:17:29 PM	TEXAS INSTRUMENTS	

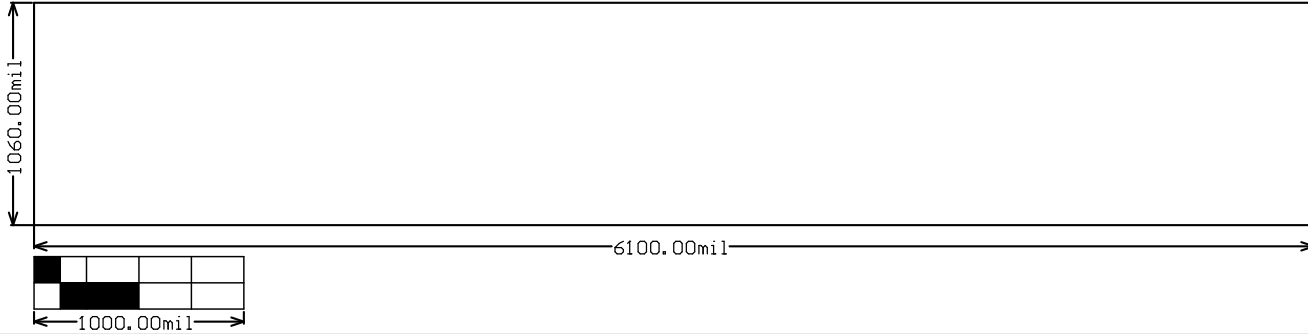


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01463	REV: A	SUN REV: Not In VersionControl
LAYER NAME =	TID #: TIDA-01463		
PLOT NAME = Bottom Solder Mask	GENERATED : 11/2/2017 2:17:31 PM	TEXAS INSTRUMENTS	



Symbol	Quantity	Finished Hole Size	Plated	Hole Type	Drill Layer Pair	Hole Tolerance
☆	21	7.87mil (0.200mm)	PTH	Round	Top Layer - Bottom Layer	
○	184	8.00mil (0.203mm)	PTH	Round	Top Layer - Bottom Layer	
■	11	12.00mil (0.305mm)	PTH	Round	Top Layer - Bottom Layer	
⊕	50	18.00mil (0.457mm)	PTH	Round	Top Layer - Bottom Layer	
□	22	31.89mil (0.810mm)	PTH	Round	Top Layer - Bottom Layer	+/-1.97mil
⊗	8	35.04mil (0.890mm)	PTH	Round	Top Layer - Bottom Layer	
◇	2	51.18mil (1.300mm)	PTH	Round	Top Layer - Bottom Layer	
⊗	2	61.81mil (1.570mm)	PTH	Round	Top Layer - Bottom Layer	
⊕	2	128.00mil (3.251mm)	PTH	Round	Top Layer - Bottom Layer	
	302 Total					

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01463	REV: A	SUN REV: Not In VersionControl
LAYER NAME =	TID #: TIDA-01463		
PLOT NAME = Drill Drawing	GENERATED : 11/2/2017 2:17:34 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01463	REV: A	SUN REV: Not In VersionControl
LAYER NAME =	TID #: TIDA-01463		
PLOT NAME = Board Dimensions	GENERATED : 11/2/2017 2:17:36 PM	TEXAS INSTRUMENTS	

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